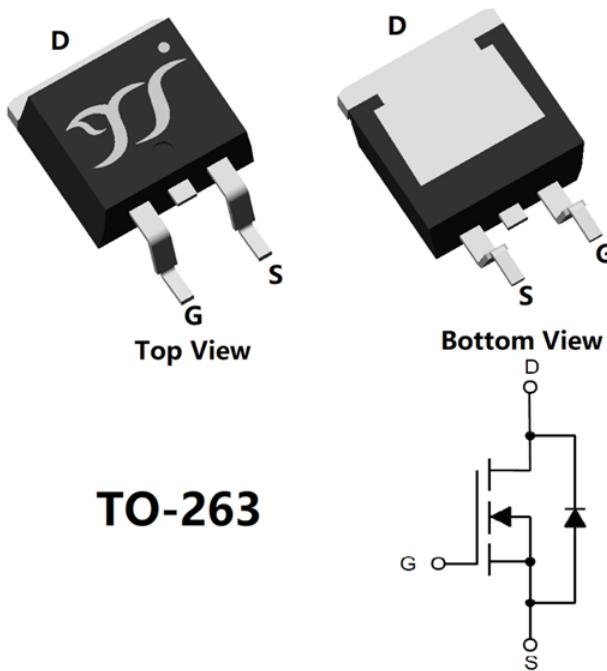


## N-Channel Enhancement Mode Field Effect Transistor

**TO-263**

### Product Summary

- $V_{DS}$  60V
- $I_D$  200A
- $R_{DS(ON)}$  (at  $V_{GS}=10V$ ) <3.2 mohm
- $R_{DS(ON)}$  (at  $V_{GS}=4.5V$ ) <4.5 mohm
- 100% EAS Tested
- 100%  $\nabla V_{DS}$  Tested

### General Description

- Excellent package for heat dissipation
- High density cell design for low  $R_{DS(ON)}$
- Moisture Sensitivity Level 1
- Epoxy Meets UL 94 V-0 Flammability Rating
- Halogen Free
- Part no. with suffix "Q" means AEC-Q101 qualified

### Applications

- Consumer electronic power supply
- Isolated DC-DC Converters
- Motor control
- Invertors

### ■ Absolute Maximum Ratings ( $T_A=25^\circ C$ unless otherwise noted)

| Parameter                              | Symbol         | Limit    | Unit |
|--|----------------|----------|------|
| Drain-source Voltage                   | $V_{DS}$       | 60       | V    |
| Gate-source Voltage                    | $V_{GS}$       | $\pm 20$ | V    |
| Drain Current <sup>A</sup>             | $I_D$          | 23       | A    |
|  |                | 15       |      |
|  |                | 200      |      |
|  |                | 125      |      |
| Pulsed Drain Current <sup>B</sup>      | $I_{DM}$       | 600      | A    |
| Avalanche energy <sup>C</sup>          | EAS            | 600      | mJ   |
| Total Power Dissipation <sup>D</sup>   | $P_D$          | 4.3      | W    |
|  |                | 1.7      |      |
|  |                | 260      |      |
|  |                | 104      |      |
| Junction and Storage Temperature Range | $T_J, T_{STG}$ | -55~+150 | °C   |

**■ Thermal resistance**

| Parameter   |              | Symbol           | Typ | Max  | Units |
|---|--------------|------------------|-----|------|-------|
| Thermal Resistance Junction-to-Ambient <sup>E</sup> | Steady-State | R <sub>θJA</sub> | 24  | 29   | °C/W  |
| Thermal Resistance Junction-to-Case                 | Steady-State | R <sub>θJC</sub> | 0.4 | 0.48 |       |

**■ Ordering Information (Example)**

| PREFERRED P/N | PACKING CODE | Marking    | MINIMUM PACKAGE(pcs) | INNER BOX QUANTITY(pcs) | OUTER CARTON QUANTITY(pcs) | DELIVERY MODE |
|---------------|--------------|------------|----------------------|-------------------------|----------------------------|---------------|
| YJB200G06CQ   | F2           | YJB200G06C | 800                  | /                       | 8000                       | 13" reel      |



# YJB200G06CQ

## ■ Electrical Characteristics ( $T_J=25^\circ\text{C}$ unless otherwise noted)

| Parameter                         | Symbol                   | Conditions   | Min | Typ  | Max       | Units            |
|-----------------------------------|--------------------------|--|-----|------|-----------|------------------|
| <b>Static Parameter</b>           |                          |  |     |      |           |                  |
| Drain-Source Breakdown Voltage    | $\text{BV}_{\text{DSS}}$ | $V_{\text{GS}}=0\text{V}, I_{\text{D}}=250\mu\text{A}$   | 60  |      |           | V                |
| Zero Gate Voltage Drain Current   | $I_{\text{DSS}}$         | $V_{\text{DS}}=60\text{V}, V_{\text{GS}}=0\text{V}$  |     |      | 1         | $\mu\text{A}$    |
| Gate-Body Leakage Current         | $I_{\text{GSS}}$         | $V_{\text{GS}}= \pm 20\text{V}, V_{\text{DS}}=0\text{V}$   |     |      | $\pm 100$ | nA               |
| Gate Threshold Voltage            | $V_{\text{GS(th)}}$      | $V_{\text{DS}}=V_{\text{GS}}, I_{\text{D}}=250\mu\text{A}$   | 1.0 | 1.6  | 2.5       | V                |
| Static Drain-Source On-Resistance | $R_{\text{DS(ON)}}$      | $V_{\text{GS}}= 10\text{V}, I_{\text{D}}=20\text{A}$   |     | 2.5  | 3.2       | $\text{m}\Omega$ |
|                                   |                          | $V_{\text{GS}}= 4.5\text{V}, I_{\text{D}}=15\text{A}$  |     | 3    | 4.5       |                  |
| Diode Forward Voltage             | $V_{\text{SD}}$          | $I_{\text{S}}=20\text{A}, V_{\text{GS}}=0\text{V}$   |     |      | 1.2       | V                |
| <b>Dynamic Parameters</b>         |                          |  |     |      |           |                  |
| Gate resistance                   | $R_{\text{G}}$           | $f=1\text{MHz}$  |     | 2    |           | $\Omega$         |
| Input Capacitance                 | $C_{\text{iss}}$         | $V_{\text{DS}}=25\text{V}, V_{\text{GS}}=0\text{V}, f=100\text{KHZ}$                                 |     | 6000 |           | $\text{pF}$      |
| Output Capacitance                | $C_{\text{oss}}$         |  |     | 1300 |           |                  |
| Reverse Transfer Capacitance      | $C_{\text{rss}}$         |  |     | 47   |           |                  |
| <b>Switching Parameters</b>       |                          |  |     |      |           |                  |
| Total Gate Charge                 | $Q_{\text{g}}$           | $V_{\text{GS}}=10\text{V}, V_{\text{DS}}=30\text{V}, I_{\text{D}}=45\text{A}$                        |     | 85   |           | $\text{nC}$      |
| Gate-Source Charge                | $Q_{\text{gs}}$          |  |     | 23   |           |                  |
| Gate-Drain Charge                 | $Q_{\text{gd}}$          |  |     | 9.3  |           |                  |
| Reverse Recovery Charge           | $Q_{\text{rr}}$          | $I_{\text{S}}=45\text{A}, di/dt=100\text{A/us},$   |     | 61   |           | $\text{ns}$      |
| Reverse Recovery Time             | $t_{\text{rr}}$          |  |     | 54   |           |                  |
| Turn-on Delay Time                | $t_{\text{d(on)}}$       | $V_{\text{GS}}=10\text{V}, V_{\text{DS}}=30\text{V}, I_{\text{D}}=45\text{A} R_{\text{GEN}}=3\Omega$ |     | 18.5 |           | $\text{ns}$      |
| Turn-on Rise Time                 | $t_{\text{r}}$           |  |     | 87   |           |                  |
| Turn-off Delay Time               | $t_{\text{d(off)}}$      |  |     | 64   |           |                  |
| Turn-off fall Time                | $t_{\text{f}}$           |  |     | 107  |           |                  |

### Note:

- A. The maximum current rating is package limited.
- B. Repetitive rating; pulse width limited by max. junction temperature.
- C.  $T_J=25^\circ\text{C}, V_{\text{DD}}=50\text{V}, V_{\text{GS}}=10\text{V}, R_{\text{G}}=25\Omega, L=0.5\text{mH}, I_{\text{AS}}=49\text{A}$ .
- D.  $P_D$  is based on max. junction temperature, using junction-case thermal resistance.
- E. The value of  $R_{\text{GJA}}$  is measured with the device mounted on 1 in 2 FR-4 board with 2oz. Copper, in a still air environment with  $T_a=25^\circ\text{C}$ .



## ■ Typical Performance Characteristics

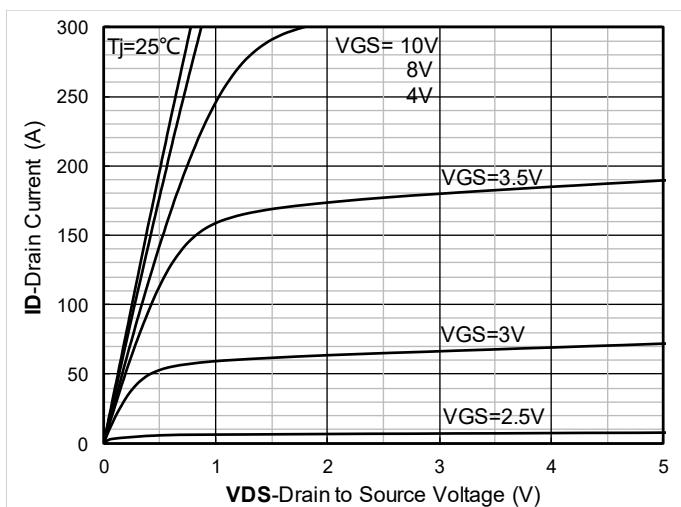


Figure1. Output Characteristics

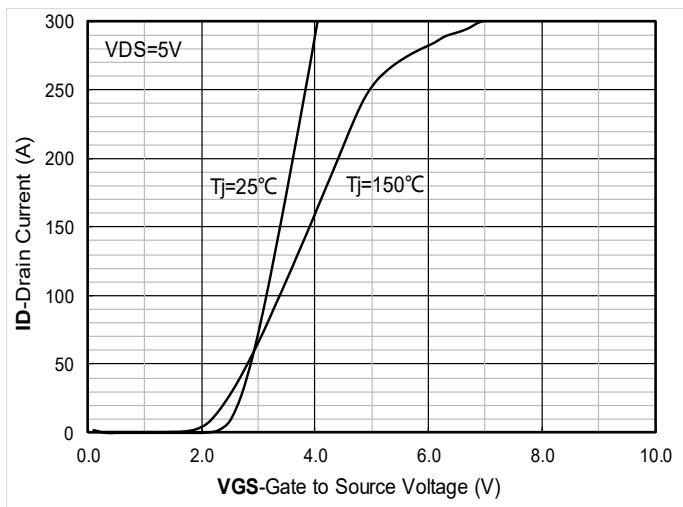


Figure2. Transfer Characteristics

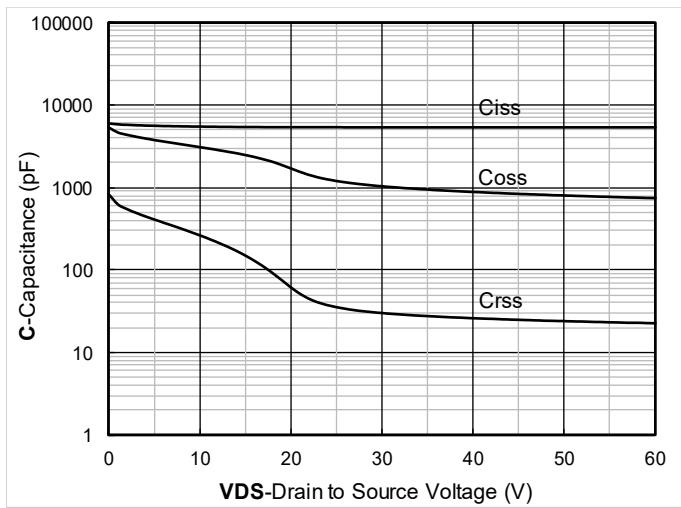


Figure3. Capacitance Characteristics

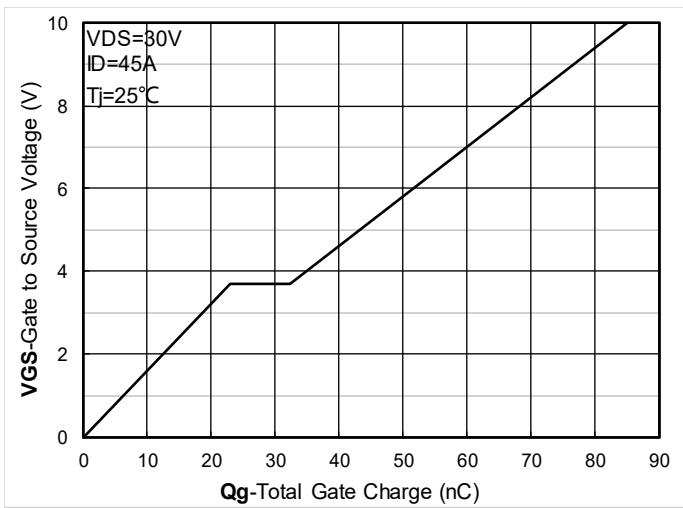


Figure4. Gate Charge

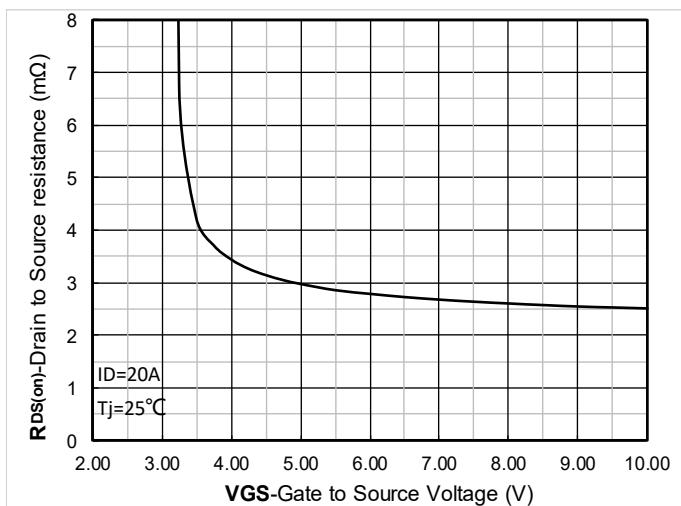


Figure 5. On-Resistance vs Gate to Source Voltage

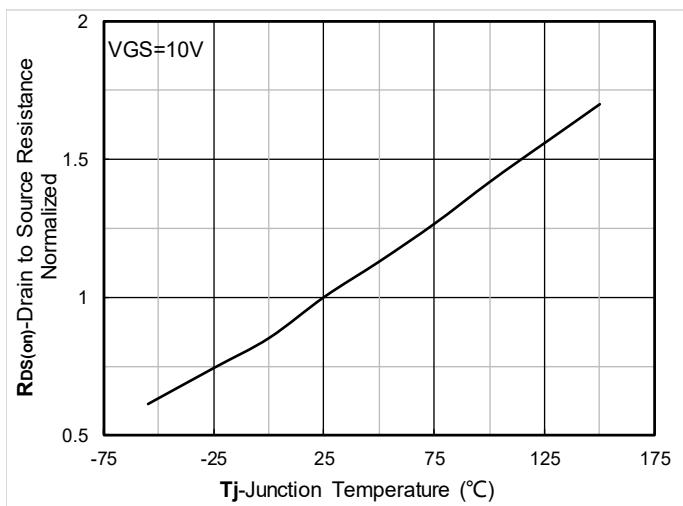


Figure 6. Normalized On-Resistance

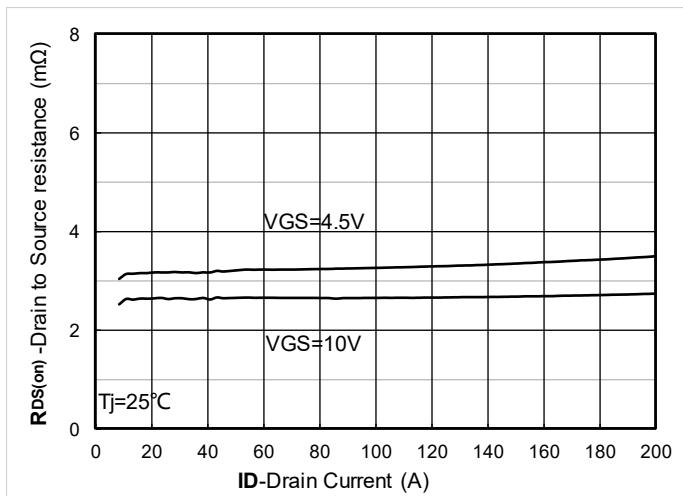


Figure 7.  $R_{DS(on)}$  VS Drain Current

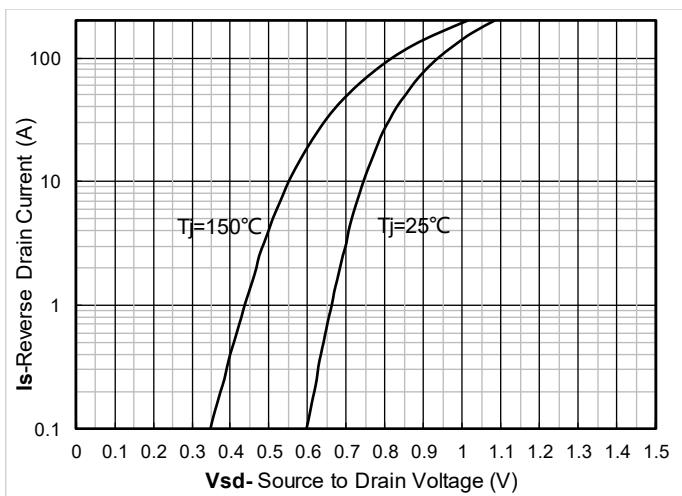


Figure 8. Forward characteristics of reverse diode

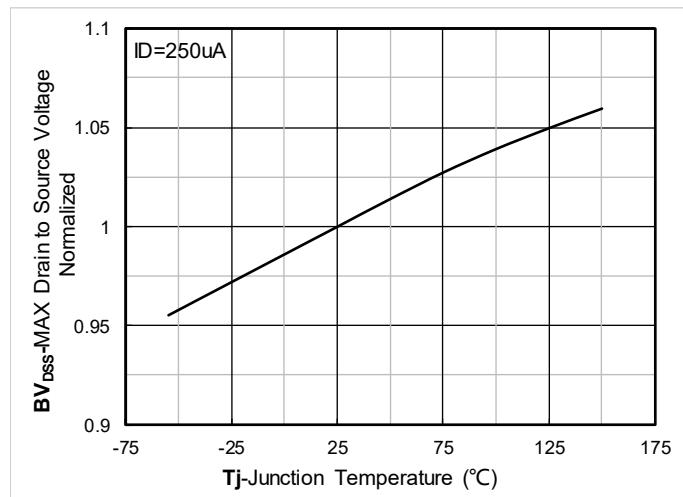


Figure 9. Normalized breakdown voltage

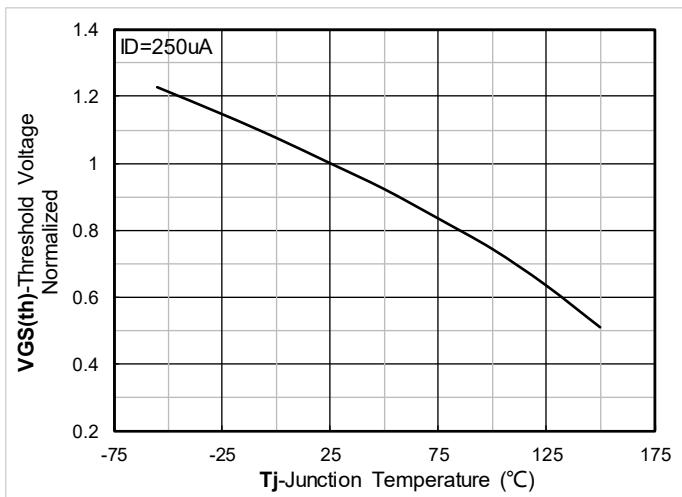


Figure 10. Normalized Threshold voltage

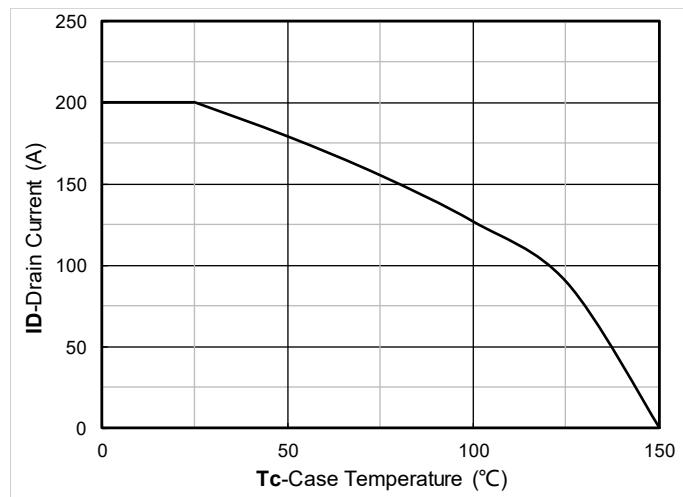


Figure 11. Current dissipation

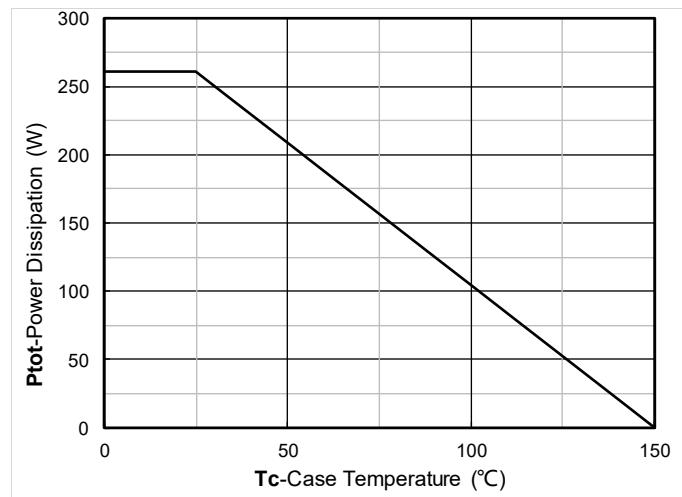


Figure 12. Power dissipation

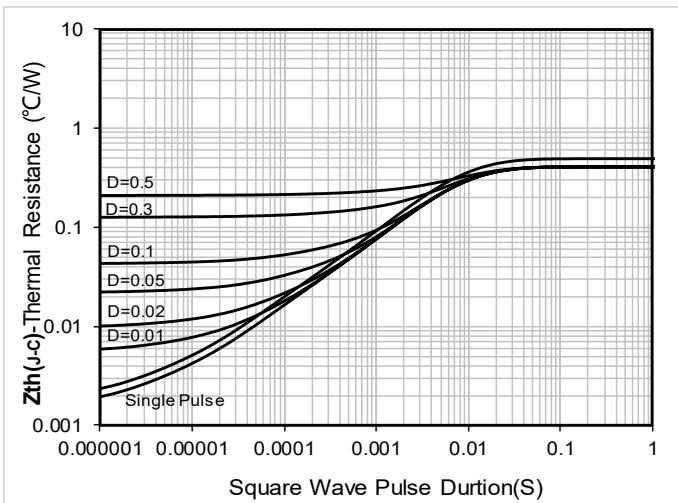


Figure 13. Maximum Transient Thermal Impedance

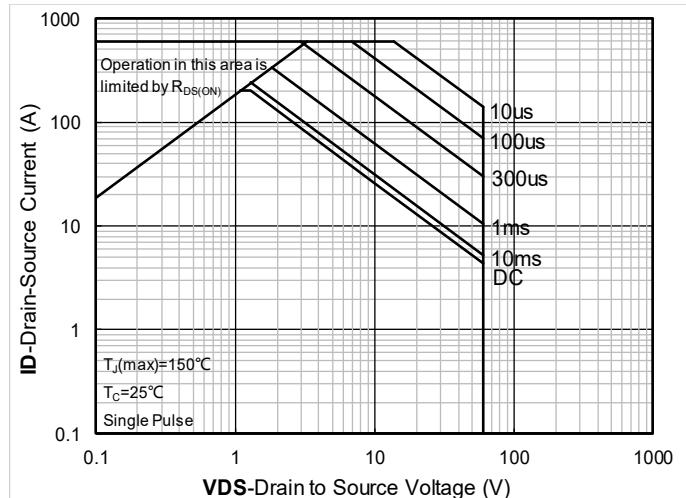
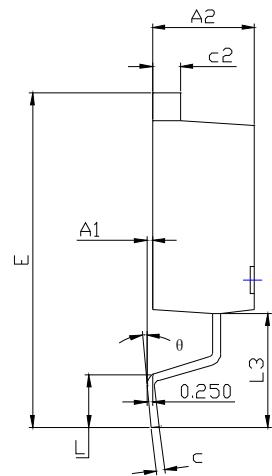
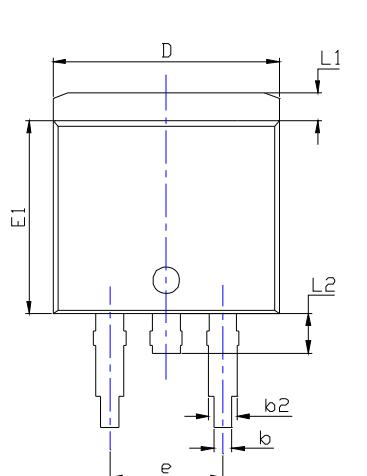


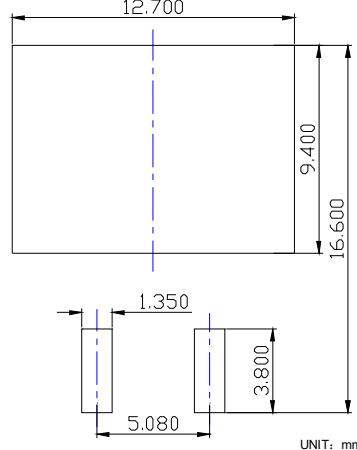
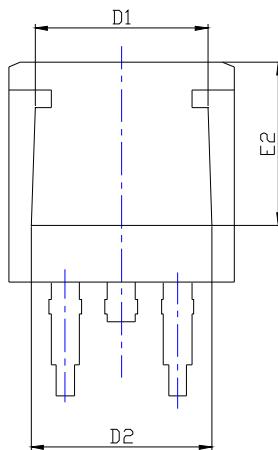
Figure 14. Safe Operation Area



## ■ TO-263-HY Package information



| SYMBOL | DIMENSIONS |       |       | Millimeter |        |        |
|--------|------------|-------|-------|------------|--------|--------|
|        | MIN.       | NOM.  | MAX.  | MIN.       | NOM.   | MAX.   |
| A1     | 0.000      | ---   | 0.010 | 0.000      | ---    | 0.250  |
| A2     | 0.174      | 0.180 | 0.186 | 4.430      | 4.580  | 4.730  |
| b      | 0.028      | 0.032 | 0.036 | 0.720      | 0.820  | 0.920  |
| b2     | 0.046      | 0.050 | 0.054 | 1.180      | 1.280  | 1.380  |
| c      | 0.013      | 0.015 | 0.018 | 0.330      | 0.390  | 0.450  |
| c2     | 0.048      | 0.050 | 0.053 | 1.220      | 1.280  | 1.340  |
| D      | 0.394      | 0.400 | 0.406 | 10.000     | 10.150 | 10.300 |
| D1     | 0.295      | 0.307 | 0.319 | 7.500      | 7.800  | 8.100  |
| D2     | 0.303      | 0.315 | 0.327 | 7.700      | 8.000  | 8.300  |
| E      | 0.571      | 0.591 | 0.610 | 14.500     | 15.000 | 15.500 |
| E1     | 0.337      | 0.341 | 0.348 | 8.550      | 8.700  | 8.850  |
| E2     | 0.276      | 0.287 | 0.299 | 7.000      | 7.300  | 7.600  |
| e      | 0.200BSC   |       |       | 5.080BSC   |        |        |
| L      | 0.070      | ---   | 0.110 | 1.790      | ---    | 2.790  |
| L1     | 0.044      | ---   | 0.056 | 1.120      | ---    | 1.420  |
| L2     | 0.030      | ---   | 0.070 | 0.770      | ---    | 1.770  |
| L3     | 0.197REF   |       |       | 5.000REF   |        |        |
| theta  | 0*         | ---   | 8*    | 0*         | ---    | 8*     |



SUGGESTED SOLDER PAD LAYOUT

UNIT: mm

## NOTE:

- 1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
- 2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.
- 3.THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.



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